Docket No. 372465-01801



As a below nam	DE DE	CLARATION, POWER O	FATTORNEY AND PETITION		
As a below nam	ned inventor, I here	by declare that:			
Муге	sidence, post offic	e address and citizenship are	as stated below next to my name.		
inventor (if plu invention entitle	ral names are list ed "APPROXIM.	ed below) of the subject ma	if only one name is listed below) or an or tter which is claimed and for which a pa ETAIL CALCULATION IN CUBIC MA	tent is sought	t on the
		tached hereto filed on as Applicat	on Serial No		
I here claims, as amen	eby state that I handed by any amend	ve reviewed and understand ment referred to above.	the contents of the above identified specif	ication, includ	ding the
		to disclose information whic gulations, § 1.56(a).	h is material to the examination of this app	lication in acc	ordance
provisional app	lication(s) for pate onal application(s)	nt or inventor's certificate lis	5, United States Code, § 119 of any foreign ted below and have also identified below a ficate having a filing date before that of the	ny foreign app	plication
		Prior Foreign/U.S. Pr	ovisional Application(s)		
				Priority (	Claimed
60/449,123	United States	20 February 2003		$\boxtimes$	
(Number)	(Country)	(Day, month, year filed		Yes	No
		(2)		☐ Yes	□ No
(Number)	(Country)	(Day, month, year filed	)		
(Number)	(Country)	(Day, month, year filed	)	☐ Yes	No
and, insofar as the manner pro information as	the subject matter vided by the first defined in Title 3	of each of the claims of this a	ates Code, § 120 of any United States appl pplication is not disclosed in the prior Unite States Code, § 112, I acknowledge the duns, § 1.56(a) which occurred between the this application:	ty to disclose	cation in material
(Application Se	erial No.)	Filing Date	(Status: Patented	, pending, aba	ndoned)
(Application Se	erial No.)	Filing Date	(Status: Patented	, pending, aba	indoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Docket No. 372465-01801

And I hereby appoint J. BOYCE, REG. 40,920; A.B. DIEPENBROCK III, REG. 39,960; L. SHERRY, REG. 43,918; G. GARCIA, REG. 50,899, all associated with Dechert LLP, 975 Page Mill Road, Palo Alto, California 94304, (650) 813-4800, as my attorneys with full power of substitution and revocation, to prosecute said application and to transact in connection therewith all business in the Patent and Trademark Office and before competent International Authorities.

Address all telephone calls to Anthony B. Diepenbrock III, Esq. at (650) 813-4853 and address all correspondence to:

Anthony B. Diepenbrock III, Esq.
DECHERT LLP
Customer No. 37509
P.O. Box 10004
Palo Alto, CA 94303-0961
Tel. 650.813.4800
Fax. 650.813.4848

Wherefore I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

Full Name of First Inventor:	Qun Feng (Fred) LIAO	_
Home Address:	3466 Mauron Place, San Jose, California 95148	_
Post Office Address:	Same as above	
Citizenship:	P.R. China	_
Inventor's Signature:	Ourkni	Date: Feb 17, 2004
Full Name of Second Inventor:	Zhou (Mike) HONG	_
Home Address:	11512 Country Spring Court, Cupertino, California 95014	
Post Office Address:	Same as above	_
Citizenship:	P.R. China	_ 0_
Inventor's Signature:		Date: